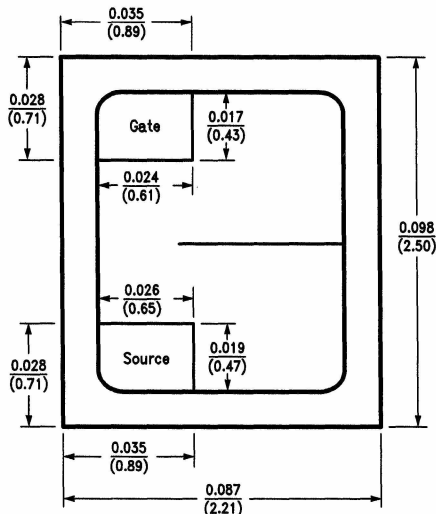




TL/G/10040-1

DESCRIPTION

These dice are n-channel, enhancement mode, power MOSFETs designed especially for high power, high speed applications, such as power supplies, AC and DC motor control and high energy pulse circuits.

This process is available in the following device types:

TO-220 (Case 37)

IRF510

IRF511

IRF512

IRF513

MTP4N08

MTP4N10

Electrical Characteristics $T_C = 25^\circ\text{C}$ (unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Max	Units
V_{DS}	Drain to Source Voltage (Note 1)	$I_D = 250 \mu\text{A}; V_{GS} = 0\text{V}$	100		V
I_{DSS}	Zero Gate Voltage Drain	$V_{DS} = \text{Rated Voltage}$ $V_{GS} = 0\text{V}$		250	μA
I_{GSS}	Gate Leakage Current	$V_{DS} = \pm 20\text{V}; V_{GS} = 0\text{V}$		100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$I_D = 250 \mu\text{A}; V_{DS} = V_{GS}$	2.0	4.0	V
$R_{DS(ON)}$	Static On-Resistance (Note 2)	$V_{GS} = 10\text{V}; I_D = 2.0\text{A}$		0.60	Ω
g_{FS}	Forward Transconductance	$V_{DS} = 10\text{V}; I_D = 2.0\text{A}$	1.0		Siemens
C_{iss}	Input Capacitance	$V_{DS} = 25\text{V}; V_{GS} = 0\text{V}$ $f = 1 \text{ MHz}$		200	pF
C_{oss}	Output Capacitance			100	pF
C_{rss}	Reverse Transfer			30	pF
$t_{d(on)}$	Turn-On Delay Time (Note 3)	$V_{DD} = 50\text{V}; I_D = 2.0\text{A}$ $V_{GS} = 10\text{V}; R_{GEN} = 50\Omega$		20	ns
t_r	Rise Time	$R_{GS} = 50\Omega$		25	ns
$t_{d(off)}$	Turn-Off Delay Time			25	ns
t_f	Fall Time			20	ns
Q_g	Total Gate Charge	$V_{GS} = 10\text{V}; I_D = 8.0\text{A}$ $V_{DD} = 40\text{V}$		7.5	nC

Note 1: $T_J = +25^\circ\text{C}$ to $+150^\circ\text{C}$.

Note 2: Pulse Test: Pulse Width $\leq 80 \mu\text{s}$, Duty Cycle $\leq 1\%$.

Note 3: Switching time measurements performed on LEM TR-58 test equipment.

Typical Performance Characteristics

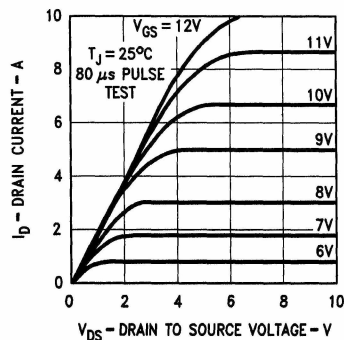


FIGURE 1. Output Characteristics

TL/G/10040-2

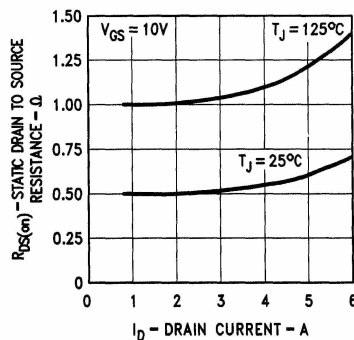


FIGURE 2. Static Drain to Source Resistance vs Drain Current

TL/G/10040-3

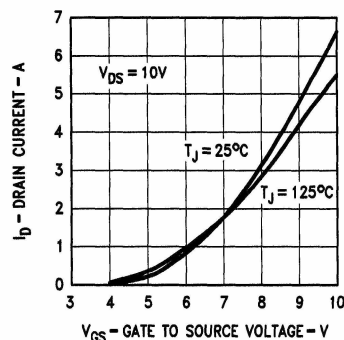


FIGURE 3. Transfer Characteristics

TL/G/10040-4

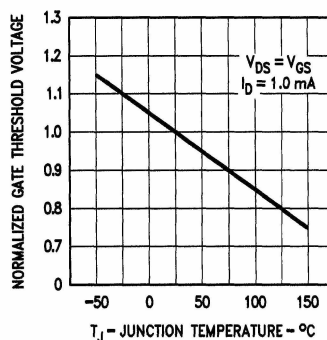


FIGURE 4. Temperature Variation of Gate to Source Threshold Voltage

TL/G/10040-5

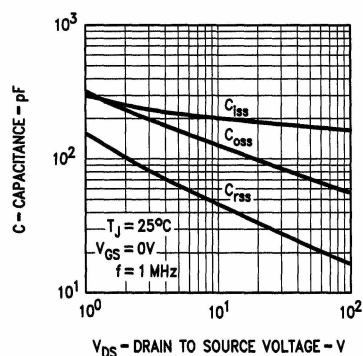


FIGURE 5. Capacitance vs Drain to Source Voltage

TL/G/10040-6

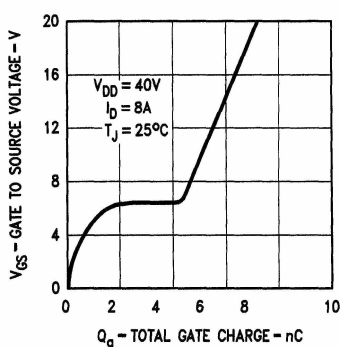
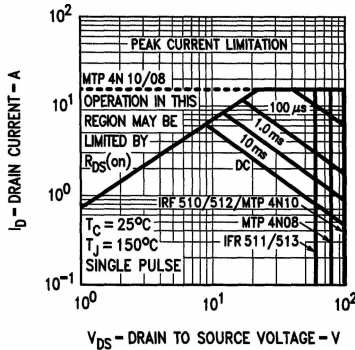


FIGURE 6. Gate to Source Voltage vs Total Gate Charge

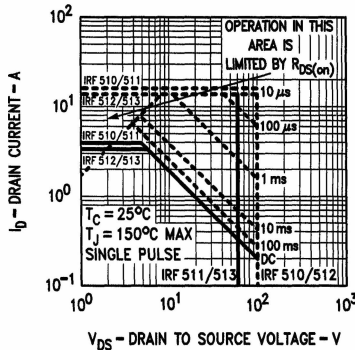
TL/G/10040-7

Typical Performance Characteristics (Continued)



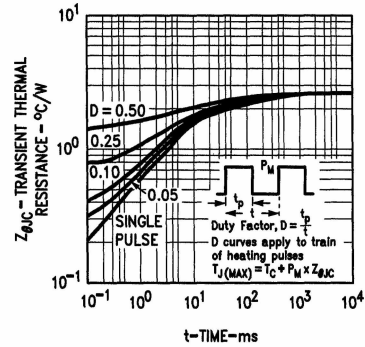
TL/G/10040-8

FIGURE 7. Forward Biased Safe Operating Area for MTP4N08/4N10



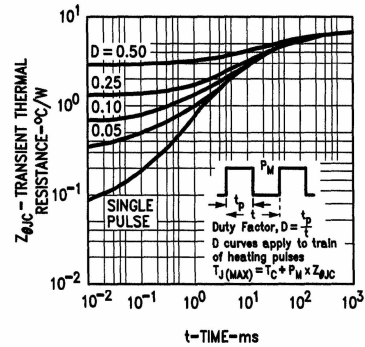
TL/G/10040-10

FIGURE 9. Forward Biased Safe Operating Area for IRF510-513



TL/G/10040-9

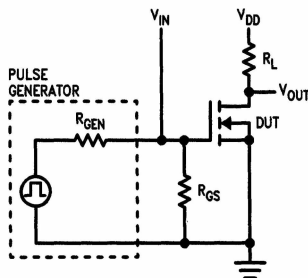
FIGURE 8. Transient Thermal Resistance vs Time for MTP4N08/4N10



TL/G/10040-11

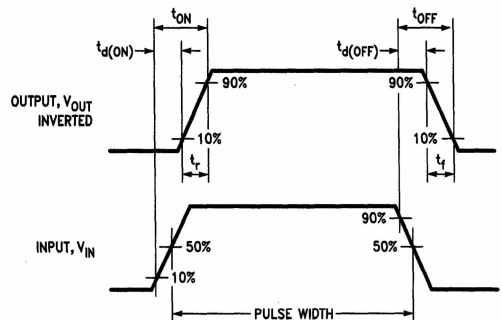
FIGURE 10. Transient Thermal Resistance vs Time for IRF510-513

Typical Electrical Characteristics



TL/G/10040-12

FIGURE 11. Switching Test Circuit



TL/G/10040-13

FIGURE 12. Switching Waveforms